Schottky Barrier Diode

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.

Features

- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.385 V (max) @ $I_F = 10 \text{ mA}$
- Low Reverse Current
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|-------|------|
| Reverse Voltage | V _R | 30 | Vdc |
| Forward Current DC | ١ _F | 100 | mA |
| Forward Current Surge Peak (60 Hz, 1 cycle) | I _{FSM} | 1.0 | A |
| ESD Rating: Class 3B per Human Body Model Class B per Machine Model | | | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Мах | Unit |
|--|-----------------------------------|----------------|-------|
| Total Device Dissipation FR–5 Board, (Note 1) $T_A = 25^{\circ}C$ | P _D | 200 | mW |
| Derate above 25°C | | 2.0 | mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 600 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | –55 to +125 | °C |

1. FR-5 Minimum Pad.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

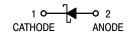
| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|----------------|-----|-----|----------------|------|
| Reverse Leakage (V _R = 10 V) (V _R = 30 V) | I _R | 1 1 | | 0.35 3.0 | μΑ |
| Forward Voltage (I _F = 10 mA) (I _F = 100 mA) | V _F | | | 0.385 0.525 | Vdc |

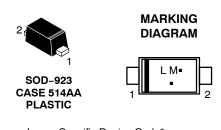


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30 V SCHOTTKY BARRIER DIODE





L = Specific Device Code* (Character is rotated 270° clockwise)

M = Month Code

= Pb-Free Package

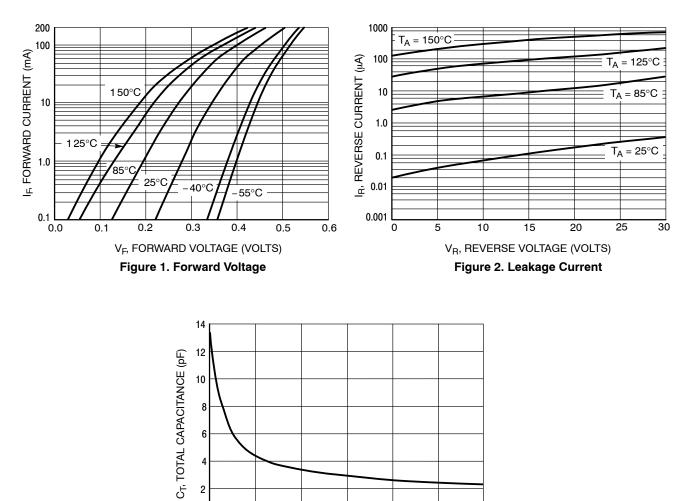
(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping† |
|--------------|---------|--------------------------------|
| NSR0130P2T5G | SOD-923 | 2 mm Pitch 8000/Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSR0130P2



V_R, REVERSE VOLTAGE (VOLTS) Figure 3. Total Capacitance

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor®



SOD-923 CASE 514AB-01 **ISSUE C** DATE 11 MAR 2011 STYLE 1 STYLE 2 SCALE 8:1 -X-D NOTES: NOTES:
DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
CONTROLLING DIMENSION: MILLIMETERS.
MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
DIMENSIONS ON DE DE DOMET NICULES MOL DE DUDE DOMESTICS. -Y-DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. 4. 2X L |⊕| 0.08 | X | Y **TOP VIEW** MILLIMETERS INCHES DIM MIN NOM MAX MIN NOM MAX
 A
 0.34
 0.37
 0.40
 0.013
 0.015
 0.016

 b
 0.15
 0.20
 0.25
 0.006
 0.008
 0.010
 Δ
 c
 0.07
 0.12
 0.17
 0.003
 0.005
 0.007

 D
 0.75
 0.80
 0.85
 0.030
 0.031
 0.033

 E
 0.55
 0.60
 0.65
 0.022
 0.024
 0.026

 He
 0.95
 1.00
 1.05
 0.037
 0.039
 0.041
 0.95 1.00 1.05 0.037 0.039 0.041 L L2 0.19 REF 0.007 REF 0.05 0.10 0.15 0.002 0.004 0.006 С H_{E} GENERIC SIDE VIEW **MARKING DIAGRAM*** 2X L ΧM STYLE 1 STYLE 2 2X L2-Х = Specific Device Code **BOTTOM VIEW** = Date Code Μ *This information is generic. Please refer to **SOLDERING FOOTPRINT*** device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " .", 1.20 ^{2X} 0.36 may or may not be present. 2X 0.25 STYLE 2: NO POLARITY STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE PACKAGE OUTLINE DIMENSIONS: MILLIMETERS See Application Note AND8455/D for more mounting details *For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and

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| STATUS: | ON SEMICONDUCTOR STANDARD | accessed directly from the Document versions are uncontrolled except | . , | |
| NEW STANDARD: | | "CONTROLLED COPY" in red. | | |
| DESCRIPTION: | SOD-923, 1.0X0.6X0.37, MAX HEIGHT 0. | 40 | PAGE 1 OF 2 | |





DOCUMENT NUMBER: 98AON23284D

PAGE 2 OF 2

| ISSUE | REVISION | DATE |
|-------|--|-------------|
| 0 | RELEASED FOR PRODUCTION. REQ. BY J. DAUGHERTY. | 29 AUG 2006 |
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| В | CREATED CATHODE AND NON-CATHODE BAND VERSIONS. REQ. BY J. DAUGHERTY. | 07 MAR 2007 |
| С | ADDED BOTTOM VIEW AND DIMENSION L2. MODIFIED SOLDER FOOTPRINT. REQ. BY D. TRUHITTE. | 11 MAR 2011 |
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